Low-Voltage CMOS Octal Buffer

With 5 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

MC74LCX244

The MC74LCX244 is a high performance, non-inverting octal buffer operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows MC74LCX244 inputs to be safely driven from 5 V devices. The MC74LCX244 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24 mA at the outputs. The Output Enable (\overline{OE}) input, when HIGH, disables the output by placing them in a HIGH Z condition.

Features

- Designed for 1.65 to 5.5 V V_{CC} Operation
- 5 V Tolerant Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0 V$
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10 μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance:
 - Human Body Model >2000 V
- –Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



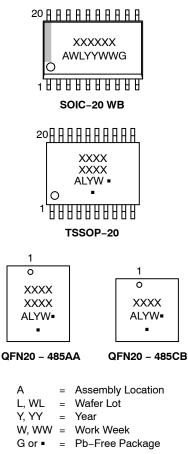


SOIC-20 WB DW SUFFIX CASE 751D

TSSOP-20 Q DT SUFFIX MN S CASE 948E CASE & 4

QFN20 MN SUFFIX CASES 485AA & 485CB

MARKING DIAGRAMS



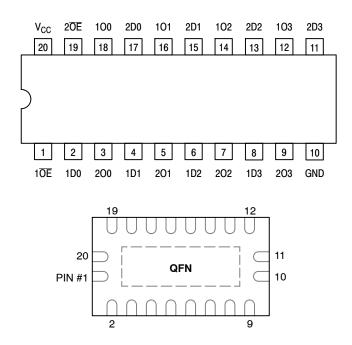
(Note: Microdot may be in either location)

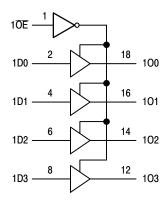
ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 8.

MC74LCX244





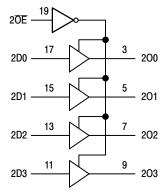


Figure 2. Logic Diagram

Figure 1. Pinouts: 20-Lead (Top View)

PIN NAMES

PINS	FUNCTION			
nOE	Output Enable Inputs			
1Dn, 2Dn	Data Inputs			
10n, 20n	3-State Outputs			

TRUTH TABLE

INP	UTS	OUTPUTS
10E 20E	1Dn 2Dn	10n, 20n
L	L	L
L	Н	н
Н	Х	Z

H = High Voltage Level

L = Low Voltage Level

Z = High Impedance State

X = High or Low Voltage Level and Transitions are Acceptable

For I_{CC} reasons, DO NOT FLOAT Inputs

MC74LCX244

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		–0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
	DC Output Voltage (Note 1) Active-Mode	e (High or Low State)	–0.5 to V _{CC} + 0.5	
Vo		Tri-State Mode	-0.5 to +6.5	V
	Power-Dov	vn Mode (V _{CC} = 0 V)	–0.5 to +6.5	1
I _{IK}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs	260	°C	
Τ _J	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC-20W	96	°C/W
		WQFN20	99	
		QFN20	111	1
		TSSOP-20	150	
PD	Power Dissipation in Still Air	SOIC-20W	1302	mW
		WQFN20	1256	
		QFN20	1127	
		TSSOP-20	833	
MSL	Moisture Sensitivity	SOIC-20W All Other Packages	Level 3 Level 1	-
F _R	Flammability Rating Ox	ygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3) Ch	Human Body Model arged Device Model	> 2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. I_O absolute maximum rating must be observed.

 Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Pa	rameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode (V _{CC} = 0 V)	0 0 0	- - -	V _{CC} 5.5 5.5	V
T _A	Operating Free–Air Temperature		-55	-	+125	°C
t _r , t _f	Input Rise or Fall Rate	$\label{eq:V_CC} \begin{array}{c} {\sf V}_{CC} = 1.65 \; {\sf V} \; to \; 1.95 \; {\sf V} \\ {\sf V}_{CC} = 2.3 \; {\sf V} \; to \; 2.7 \; {\sf V} \\ {\sf V}_{I} \; from \; 0.8 \; {\sf V} \; to \; 2.0 \; {\sf V}, \; {\sf V}_{CC} = 3.0 \; {\sf V} \\ {\sf V}_{CC} = 4.5 \; {\sf V} \; to \; 5.5 \; {\sf V} \end{array}$	0 0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

				T _A = -40°0	C to +85°C	T _A = -55°C	to +125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage		1.65 to 1.95	0.65 x V _{CC}		0.65 x V _{CC}		V
			2.3 to 2.7	1.7		1.7		
			2.7 to 3.6	2.0		2.0		
			4.5 to 5.5	$0.7 \times V_{CC}$		$0.7 \times V_{CC}$		
V _{IL}	Low-Level Input Voltage		1.65 to 1.95		0.35 x V _{CC}		0.35 x V _{CC}	V
			2.3 to 2.7		0.7		0.7	
			2.7 to 3.6		0.8		0.8	
			4.5 to 5.5		$0.3 \times V_{CC}$		$0.3 \times V_{CC}$	
V _{OH}	High-Level	$V_{I} = V_{IH} \text{ or } V_{IL}$						V
	Output Voltage	I _{OH} = -100 μA	1.65 to 5.5	$V_{CC} - 0.1$	-	$V_{CC}-0.1$	-	
		I _{OH} = -4 mA	1.65	1.2	-	1.2	-	
		I _{OH} = –8 mA	2.3	1.8	-	1.8	-	
		I _{OH} = -12 mA	2.7	2.2	-	2.2	-	
		I _{OH} = -16 mA	3.0	2.4	-	2.4	-	
		I _{OH} = -24 mA	3.0	2.2	-	2.2	-	
		I _{OH} = -32 mA	4.5	3.8		3.8		
V _{OL}	Low-Level	$V_I = V_{IH} \text{ or } V_{IL}$						V
	Output Voltage	I _{OL} = 100 μA	1.65 to 5.5	-	0.1	-	0.1	
		I _{OL} = 4 mA	1.65	-	0.45	-	0.45	
		I _{OL} = 8 mA	2.3	-	0.6	-	0.6	
		I _{OL} = 12 mA	2.7	-	0.4	-	0.4	
		I _{OL} = 16 mA	3.0	-	0.4	-	0.4	
		I _{OL} = 24 mA	3.0	-	0.55	-	0.55	
		I _{OL} = 32 mA	4.5		0.6		0.6	

DC ELECTRICAL CHARACTERISTICS

				T _A = -40°C to +85°C		T _A = -55°C to +125°C		
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Мах	Min	Мах	Unit
lı	Input Leakage Current	V _I = 0 to 5.5 V	3.6	-	±5.0	-	±5.0	μΑ
I _{OZ}	3-State Output Leakage Current	$V_{I} = V_{IH} \text{ or } V_{IL},$ $V_{O} = 0 \text{ V to } 5.5 \text{ V}$	3.6	-	±5.0	-	±5.0	μA
I _{OFF}	Power Off Leak- age Current	$V_{I} = 5.5 V \text{ or}$ $V_{O} = 5.5 V$	0	-	10	-	10	μA
Icc	Quiescent Supply Current	$V_{l} = 5.5 V \text{ or GND}$	3.6	-	10	-	10	μΑ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 to 3.6	-	500	-	500	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. These values of V_I are used to test DC electrical characteristics only.

AC ELECTRICAL CHARACTERISTICS

				T _A = -40°C	C to +85°C	T _A = -55°C	to +125°C	
Symbol	Parameter	Test Condition	V _{CC} (V)	Min	Max	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay, D to O	See Figures 3 and 4	1.65 to 1.95	-	10.3	-	10.3	ns
			2.3 to 2.7	-	7.8	-	7.8	
			2.7	-	7.5	-	7.5	
			3.0 to 3.6	-	6.5	-	6.5	
			4.5 to 5.5	-	5.9	-	5.9	
t _{PZH} , t _{PZL}	Output Enable Time, OE to \overline{OE} to O	See Figures 3 and 4	1.65 to 1.95	-	13.0	-	13.0	ns
			2.3 to 2.7	-	10.0	-	10.0	
			2.7	-	9.0	-	9.0	
			3.0 to 3.6	-	8.0	-	8.0	
			4.5 to 5.5	-	7.3	-	7.3	
t _{PHZ} , t _{PLZ}	Output Disable Time, OE to O	See Figures 3 and 4	1.65 to 1.95	-	11.0	-	11.0	ns
			2.3 to 2.7	-	8.4	-	8.4	
			2.7	-	8.0	-	8.0	
			3.0 to 3.6	-	7.0	-	7.0	
			4.5 to 5.5	-	6.0	-	6.0	
t _{OSHL} , t _{OSLH}	Output to Output Skew (Note 5)		1.65 to 1.95	-	-	-	-	ns
			2.3 to 2.7	-	-	-	-	
			2.7	_	_	_	-	
			3.0 to 3.6	-	1.0	-	1.0	

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

MC74LCX244

DYNAMIC SWITCHING CHARACTERISTICS

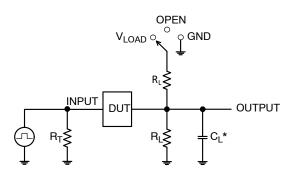
			T _A = +25°C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OLP}	Dynamic LOW Peak Voltage (Note 7)			0.8 0.6		V
V _{OLV}	Dynamic LOW Valley Voltage (Note 7)	$ \begin{array}{l} V_{CC} = 3.3 \text{ V}, \ C_L = 50 \text{ pF}, \ V_{IH} = 3.3 \text{ V}, \ V_{IL} = 0 \text{ V} \\ V_{CC} = 2.5 \text{ V}, \ C_L = 30 \text{ pF}, \ V_{IH} = 2.5 \text{ V}, \ V_{IL} = 0 \text{ V} \end{array} $		-0.8 -0.6		V

7. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Тур	Unit
C _{IN}	Input Capacitance	V_{CC} = 3.3 V, V_I = 0 V or V_{CC}	7	pF
C _{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance (Note 8)	10 MHz, V _{CC} = 3.3 V, V _I = 0 V or V _{CC}	25	pF

8. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption: P_D = C_{PD} • V_{CC2} • f_{in} + I_{CC} • V_{CC}.



Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	V _{LOAD}
t _{PHZ} / t _{PZH}	GND

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

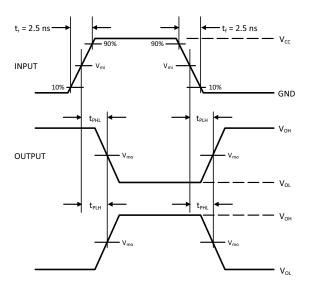
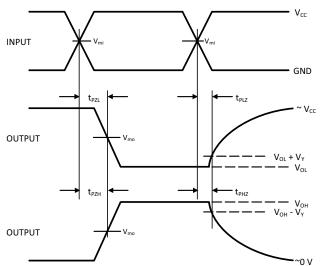


Figure 3. Test Circuit



V _{CC} , V	R_{L}, Ω	C _L , pF	V _{LOAD}	V _{mi} , V	V _{mo} , V	V _Y , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.15
2.7	500	50	6 V	1.5	V _{CC} /2	0.3
3.0 to 3.6	500	50	6 V	1.5	V _{CC} /2	0.3
4.5 to 4.5	500	50	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.3

Figure 4. Switching Waveforms

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74LCX244DWG	LCX244	SOIC-20 WB	38 Units / Rail
MC74LCX244DWR2G	LCX244	SOIC-20 WB	1000 / Tape & Reel
MC74LCX244DTG	LCX 244	TSSOP-20	75 Units / Rail
MC74LCX244DTR2G	LCX 244	TSSOP-20	2500 / Tape & Reel
MC74LCX244DTR2G-Q*	LCX 244	TSSOP-20	2500 / Tape & Reel
MC74LCX244MNTWG	LCX 244	QFN20, 2.5x4.5	3000 / Tape & Reel (4 mm pitch carrier tape)

DISCONTINUED (Note 9)

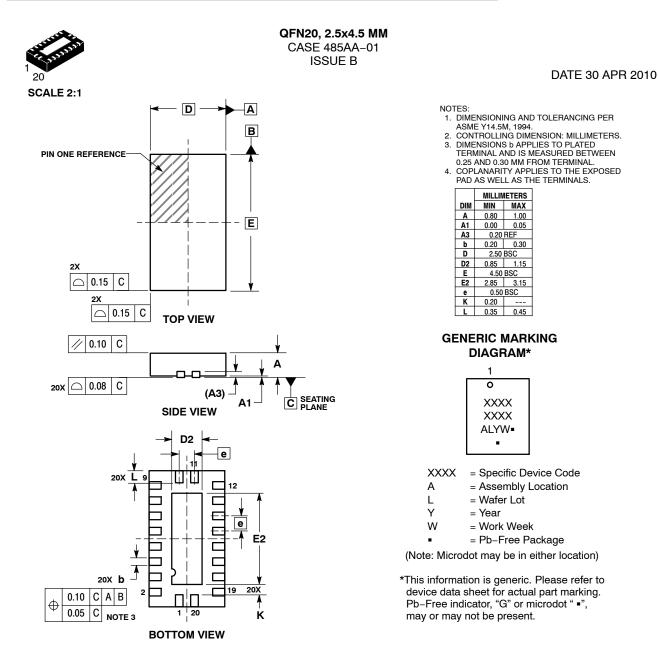
NLV74LCX244DTR2G*	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
MC74LCX244MN2TWG	QFN20, 2.5x3.5 (Pb-Free)	3000 / Tape & Reel (4 mm pitch carrier tape)

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*-Q Suffx for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

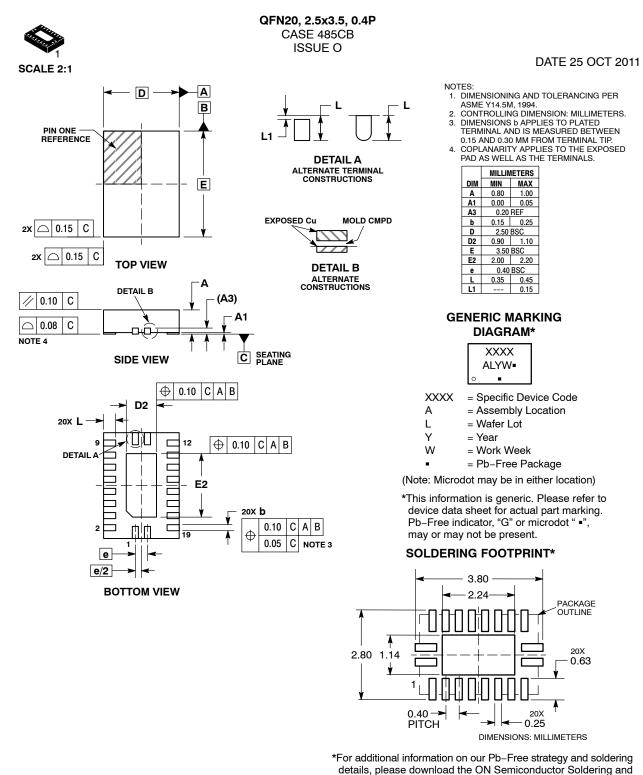
DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.





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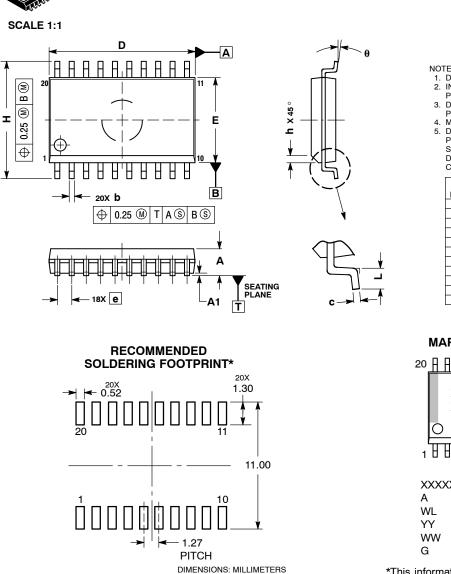




Mounting Techniques Reference Manual, SOLDERRM/D.

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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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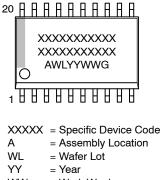
NOTES:

SOIC-20 WB CASE 751D-05 ISSUE H

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		
DIM	MIN	MAX	
Α	2.35	2.65	
A1	0.10	0.25	
b	0.35	0.49	
C	0.23	0.32	
D	12.65	12.95	
Е	7.40	7.60	
е	1.27 BSC		
Н	10.05	10.55	
h	0.25	0.75	
L	0.50	0.90	
θ	0 °	7 °	

GENERIC **MARKING DIAGRAM***

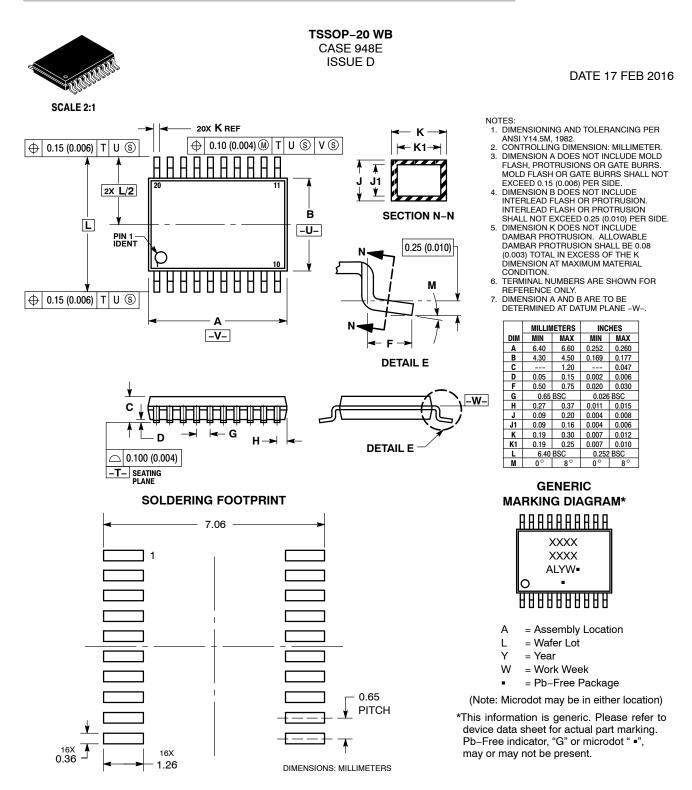


= Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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